

PS2815-1, PS2815-4

LOW (AC) INPUT CURRENT, HIGH CTR
4, 16-PIN SSOP PHOTOCOUPLER

-NEPOC Series-

DESCRIPTION

The PS2815-1 and PS2815-4 are optically coupled isolators containing GaAs light emitting diodes and an NPN silicon phototransistor in a plastic SSOP for high density applications.

The package is a Shrink SOP (Small Outline Package) type for high density mounting applications.

FEATURES

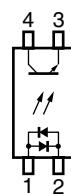
- AC input response
- High current transfer ratio (CTR = 200% TYP. @ $I_F = \pm 1$ mA)
- High isolation voltage (BV = 2 500 Vr.m.s.)
- Small and thin package (4, 16-pin SSOP, Pin pitch 1.27 mm)
- Ordering number of tape product: PS2815-1-F3, F4, PS2815-4-F3, F4
- Pb-Free product
- Safety standards: PS2815-1, -4
 - UL approved: File No. E72422
 - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

APPLICATIONS

- Programmable logic controllers
- Modem/FAX

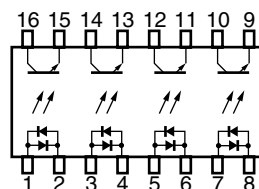
PIN CONNECTION
(Top View)

PS2815-1



1. Anode, Cathode
2. Cathode, Anode
3. Emitter
4. Collector

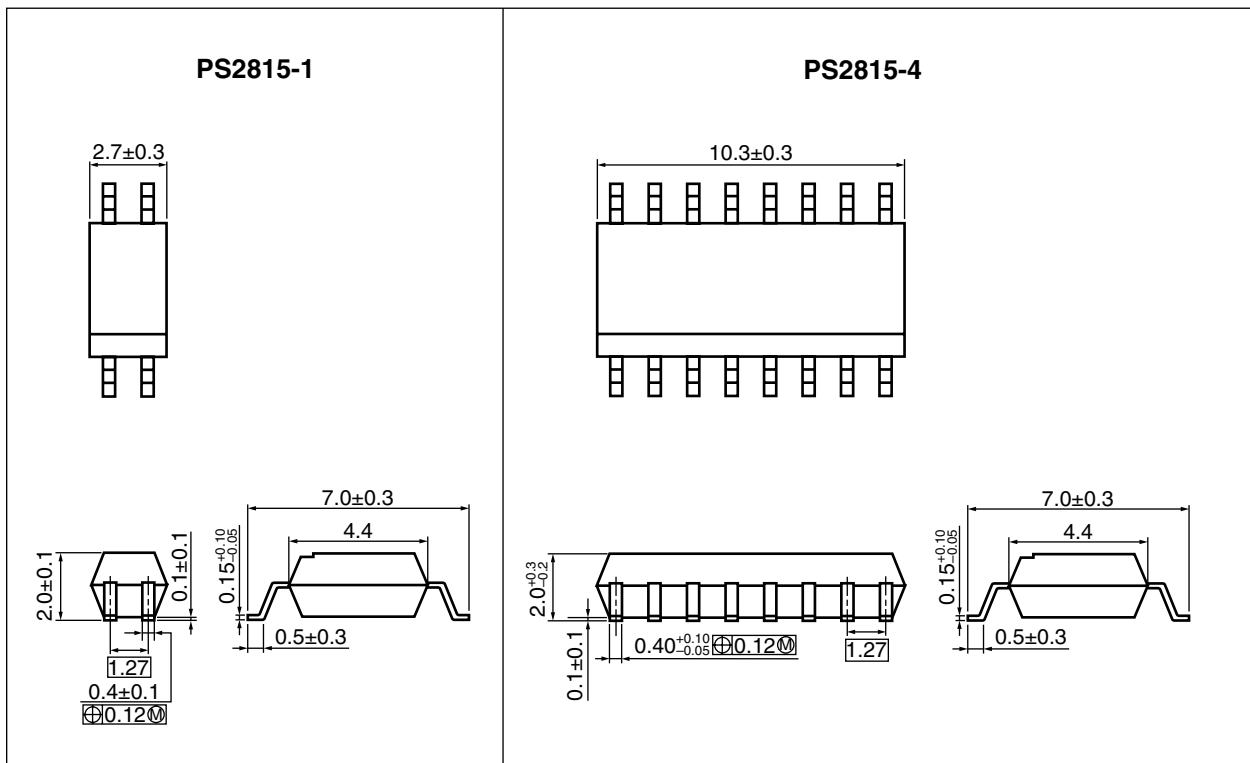
PS2815-4



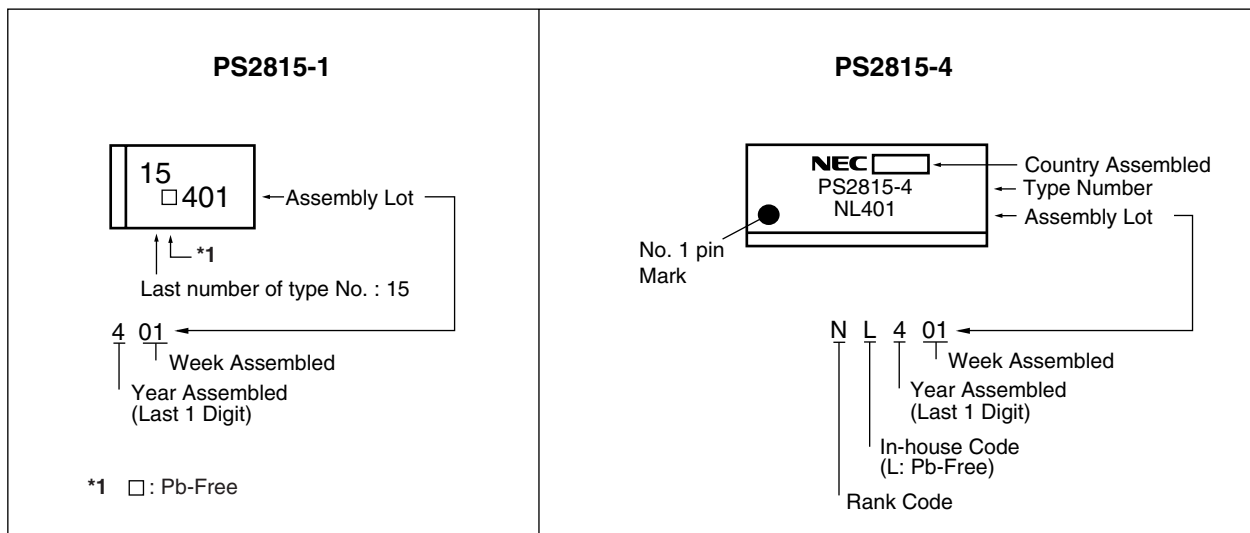
1. 3. 5. 7. Anode, Cathode
2. 4. 6. 8. Cathode, Anode
9. 11. 13. 15. Emitter
10. 12. 14. 16. Collector

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PACKAGE DIMENSIONS (UNIT: mm)



<R> MARKING EXAMPLE



<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number* ¹
PS2815-1	PS2815-1-A	Pb-Free	50 pcs (Tape 50 pcs cut)	Standard products (UL approved)	PS2815-1
PS2815-1-F3	PS2815-1-F3-A		Embossed Tape 3 500 pcs/reel		
PS2815-1-F4	PS2815-1-F4-A				
PS2815-1-V	PS2815-1-V-A		50 pcs (Tape 50 pcs cut)	DIN EN60747-5-2 (VDE0884 Part2) Approved (Option)	
PS2815-1-V-F3	PS2815-1-V-F3-A		Embossed Tape 3 500 pcs/reel		
PS2815-1-V-F4	PS2815-1-V-F4-A				
PS2815-4	PS2815-4-A		Magazine Case 45 pcs	Standard products (UL approved)	PS2815-4
PS2815-4-F3	PS2815-4-F3-A		Embossed Tape 2 500 pcs/reel		
PS2815-4-F4	PS2815-4-F4-A				
PS2815-4-V	PS2815-4-V-A		Magazine Case 45 pcs	DIN EN60747-5-2 (VDE0884 Part2) Approved (Option)	
PS2815-4-V-F3	PS2815-4-V-F3-A		Embossed Tape 2 500 pcs/reel		
PS2815-4-V-F4	PS2815-4-V-F4-A				

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings		Unit
			PS2815-1	PS2815-4	
Diode	Forward Current (DC)	I _F	±50		mA/ch
	Power Dissipation Derating	ΔP _D /°C	0.6	0.7	mW/°C
	Power Dissipation	P _D	60	70	mW/ch
	Peak Forward Current ^{*1}	I _{FP}	±1.0		A/ch
Transistor	Collector to Emitter Voltage	V _{CEO}	40		V
	Emitter to Collector Voltage	V _{ECO}	5		V
	Collector Current	I _C	40		mA/ch
	Power Dissipation Derating	ΔP _C /°C	1.2		mW/°C
	Power Dissipation	P _C	120		mW/ch
Isolation Voltage ^{*2}		BV	2 500		Vr.m.s.
Operating Ambient Temperature		T _A	-55 to +100		°C
Storage Temperature		T _{stg}	-55 to +150		°C

*1 PW = 100 μs, Duty Cycle = 1%

*2 AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output.

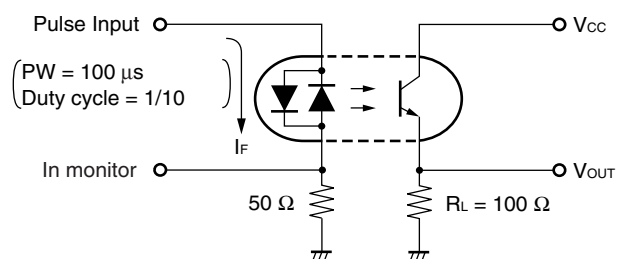
Pins 1-2 shorted together, 3-4 shorted together (PS2815-1).

Pins 1-8 shorted together, 9-16 shorted together (PS2815-4).

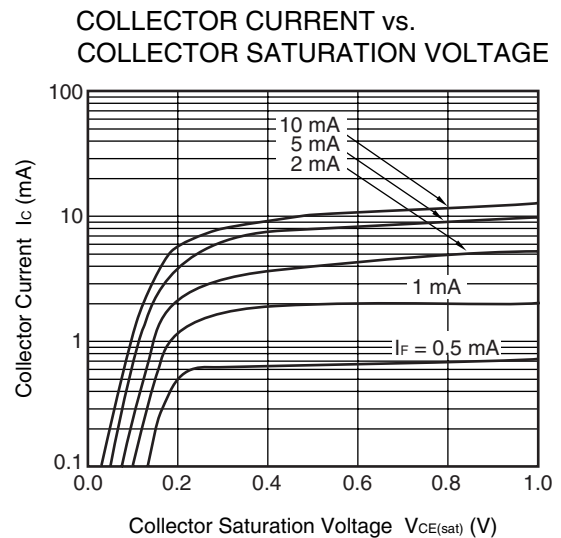
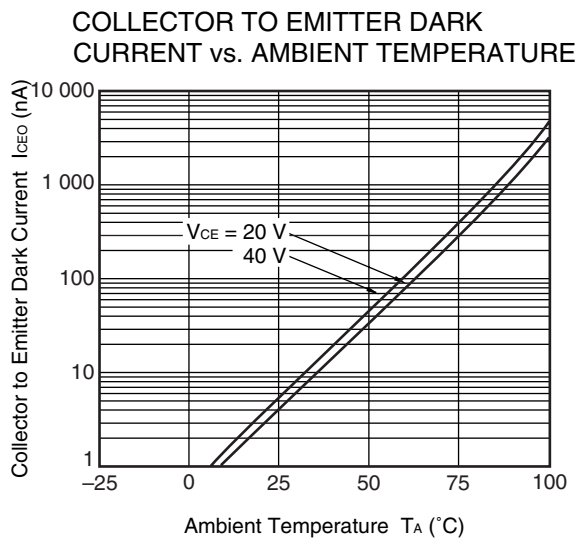
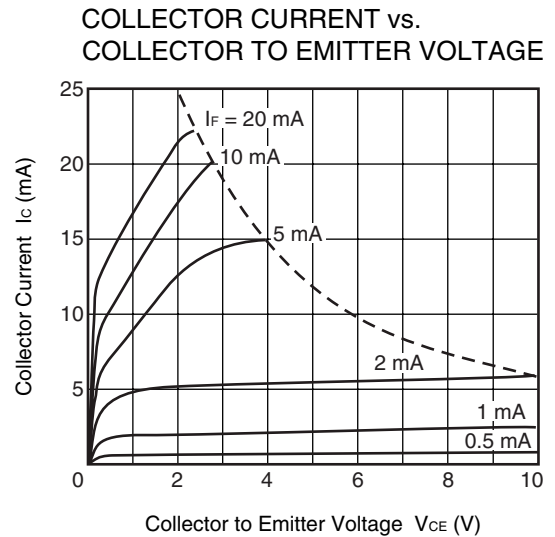
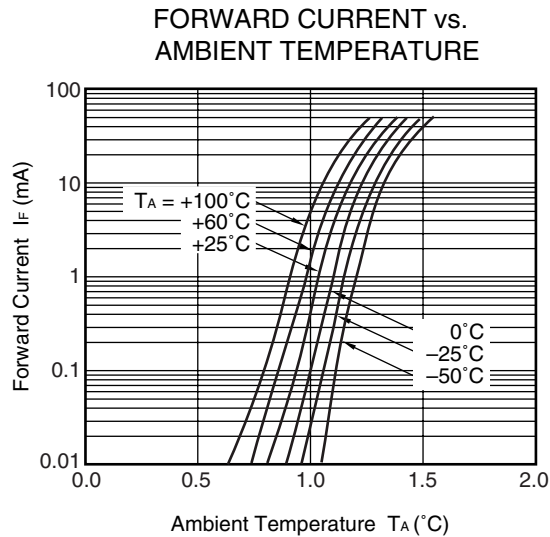
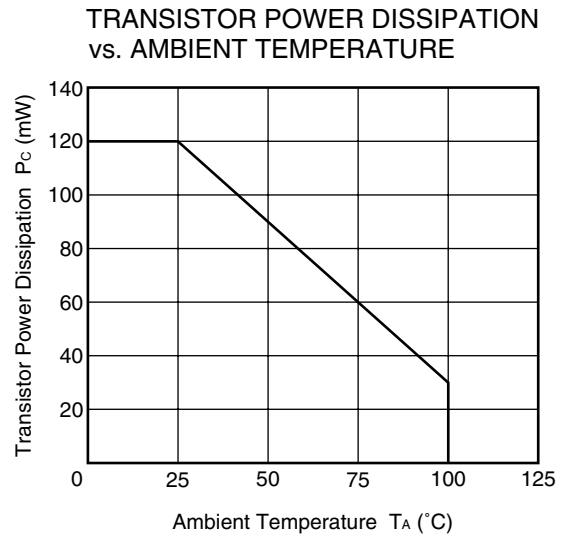
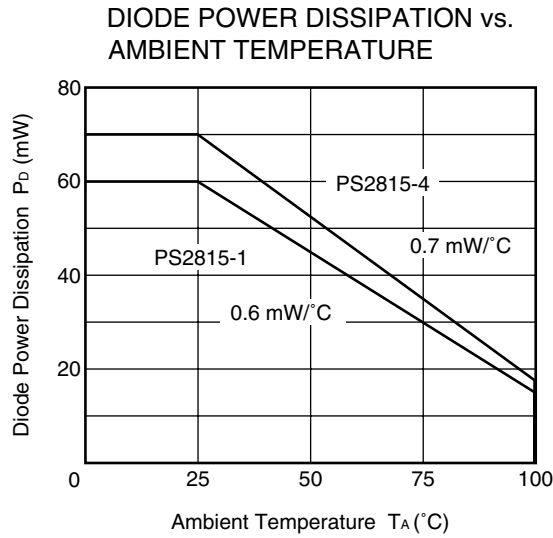
ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	V_F	$I_F = \pm 5 \text{ mA}$		1.15	1.4	V
	Terminal Capacitance	C_t	$V = 0 \text{ V}, f = 1 \text{ MHz}$		30		pF
Transistor	Collector to Emitter Dark Current	I_{CEO}	$I_F = 0 \text{ mA}, V_{CE} = 40 \text{ V}$			100	nA
Coupled	Current Transfer Ratio (I_C/I_F)	CTR	$I_F = \pm 1 \text{ mA}, V_{CE} = 5 \text{ V}$	100	200	400	%
	Collector Saturation Voltage	$V_{CE(sat)}$	$I_F = \pm 1 \text{ mA}, I_C = 0.2 \text{ mA}$			0.3	V
	Isolation Resistance	R_{I-O}	$V_{I-O} = 1 \text{ kV}_{DC}$	10^{11}			Ω
	Isolation Capacitance	C_{I-O}	$V = 0 \text{ V}, f = 1 \text{ MHz}$		0.4		pF
	Rise Time ^{*1}	t_r	$V_{CC} = 5 \text{ V}, I_C = 2 \text{ mA}, R_L = 100 \Omega$		4		μs
	Fall Time ^{*1}	t_f			5		

*1 Test circuit for switching time

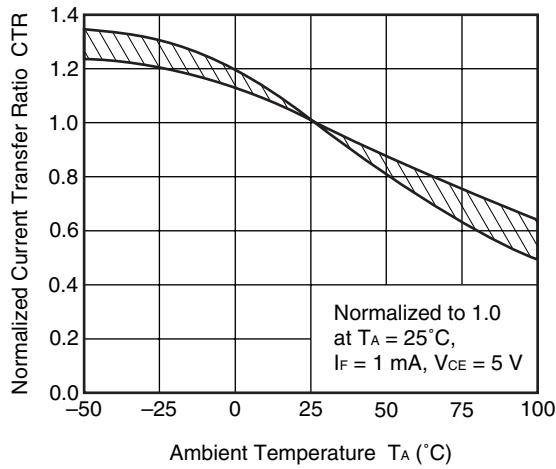


TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise specified)

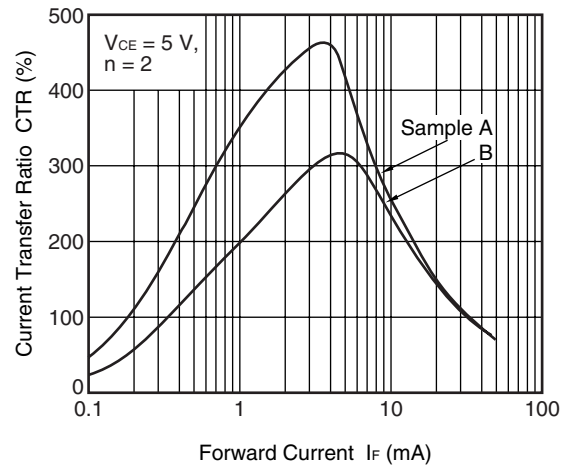


Remark The graphs indicate nominal characteristics.

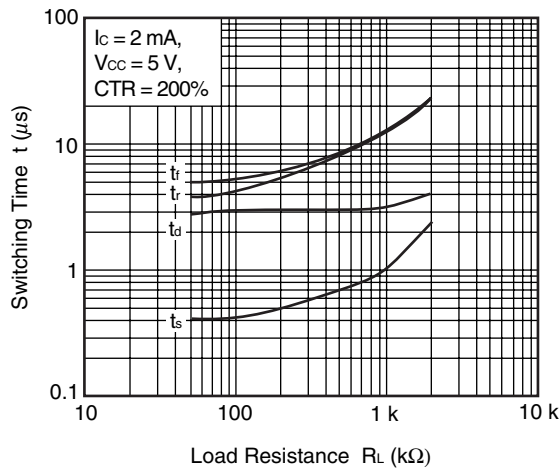
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



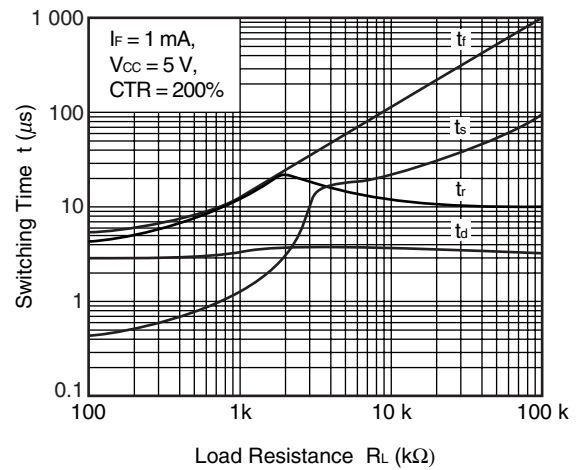
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



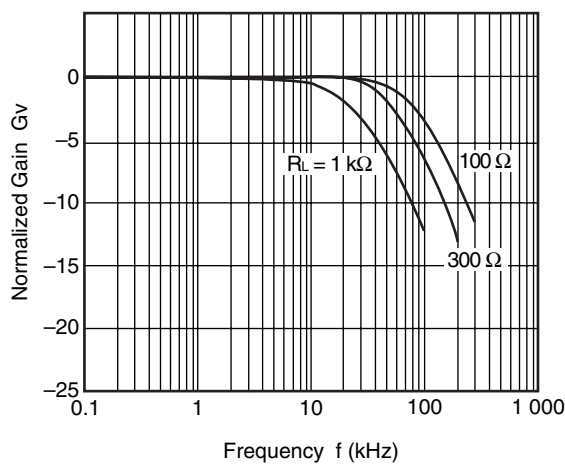
SWITCHING TIME vs. LOAD RESISTANCE



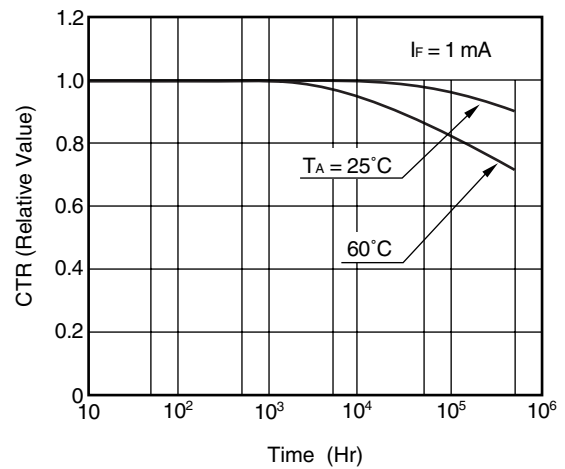
SWITCHING TIME vs. LOAD RESISTANCE



FREQUENCY RESPONSE



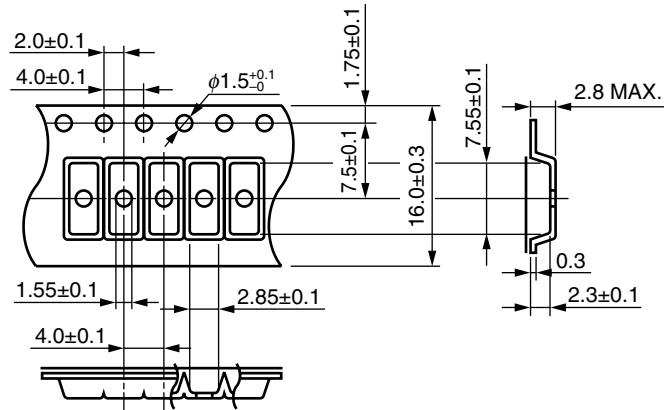
LONG TERM CTR DEGRADATION



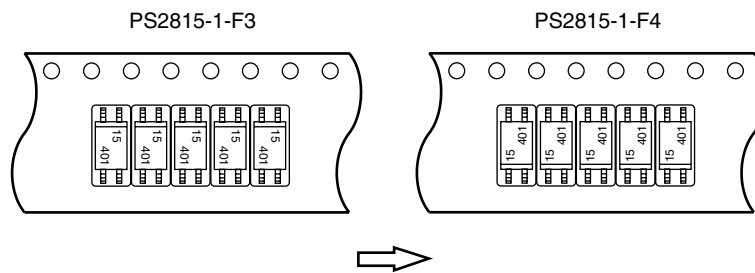
Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)

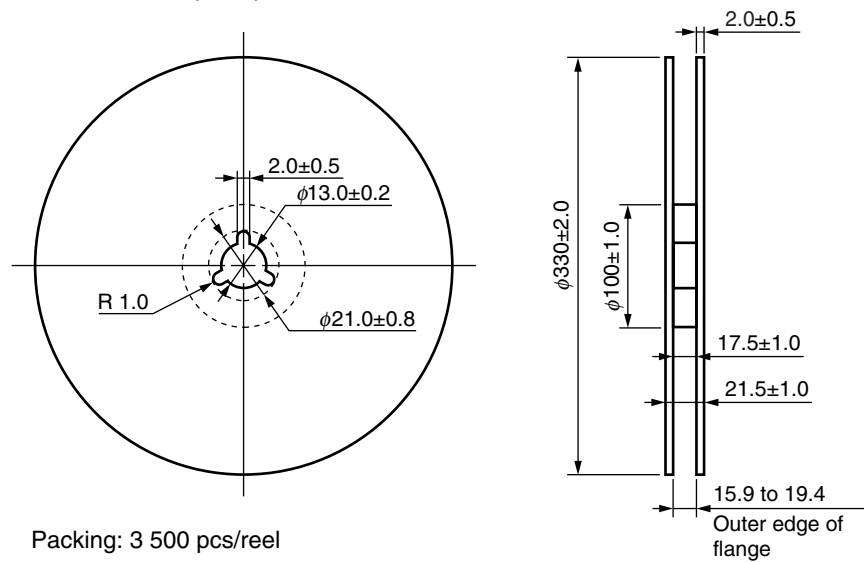
Outline and Dimensions (Tape)



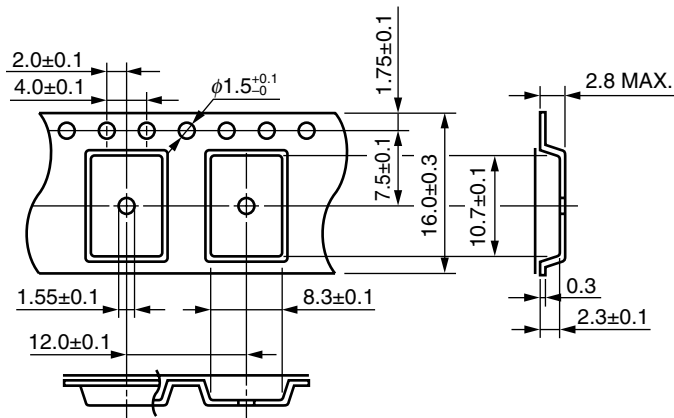
Tape Direction



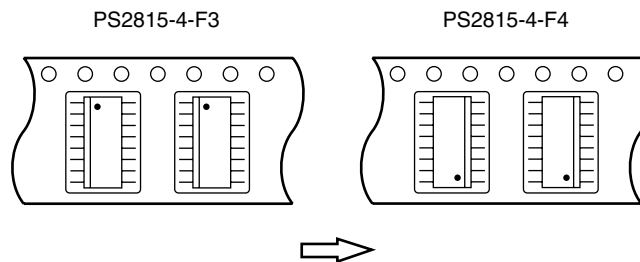
Outline and Dimensions (Reel)



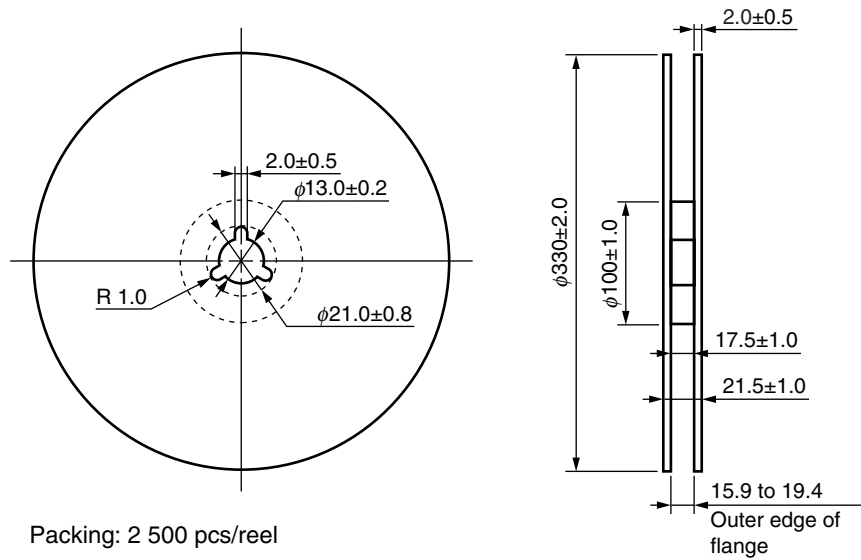
Outline and Dimensions (Tape)



Tape Direction



Outline and Dimensions (Reel)



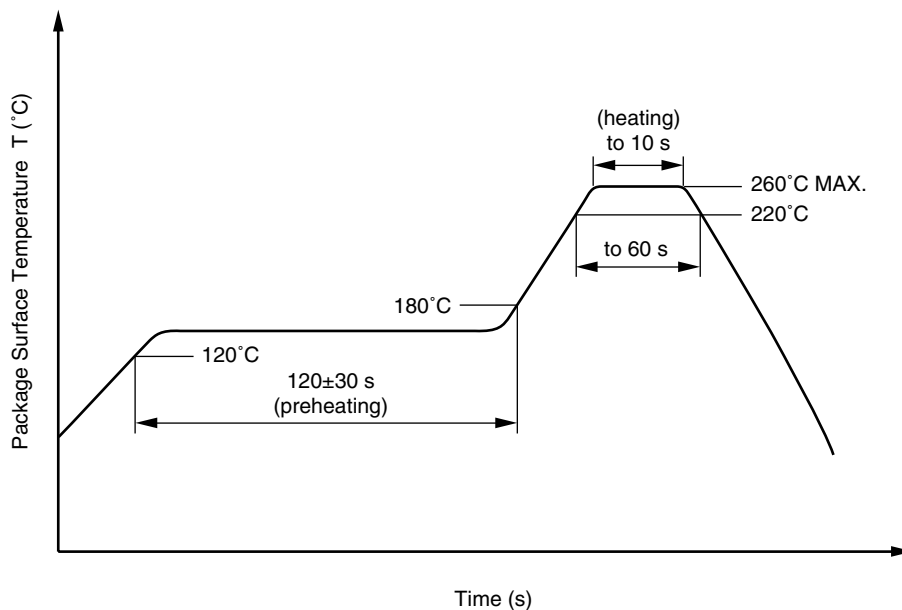
NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

- Peak reflow temperature 260°C or below (package surface temperature)
- Time of peak reflow temperature 10 seconds or less
- Time of temperature higher than 220°C 60 seconds or less
- Time to preheat temperature from 120 to 180°C 120±30 s
- Number of reflows Three
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by soldering iron

- Peak temperature (lead part temperature) 350°C or below
- Time (each pins) 3 seconds or less
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

- Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

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3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler

Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

USAGE CAUTIONS

1. Protect against static electricity when handling.
2. Avoid storage at a high temperature and high humidity.

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